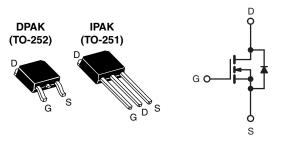
# IRFR020, IRFU020, SiHFR020, SiHFU020

Vishay Siliconix

## **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V 0.10				
Q <sub>g</sub> (Max.) (nC)	25					
Q <sub>gs</sub> (nC)	5.8					
Q <sub>gd</sub> (nC)	11					
Configuration	Single					



N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Surface Mount (IRFR020, SiHFR020)
- Available in Tape and Reel
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

# COMPLIANT HALOGEN **FREE**

### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFR020-GE3	SiHFR020TR-GE3	SiHFU020-GE3			
Lead (Pb)-free	IRFR020PbF	IRFR020TRPbF <sup>a</sup>	IRFU020PbF			
Lead (FD)-free	SiHFR020-E3	SiHFR020T-E3 <sup>a</sup>	SiHFU020-E3			

#### Note

a. See device orientation.

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	60	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	\/ at 10\/	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	- I <sub>D</sub>	14		
Continuous Diain Current	VGS at 10 V	T <sub>C</sub> = 100 °C		9.0	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount) <sup>e</sup>				0.020	W/ O	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	91	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			В	42	W	
Maximum Power Dissipation (PCB Mount) <sup>e</sup> T <sub>A</sub> = 25 °C			$P_{D}$	2.5	VV	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for	10 s		260		

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 12).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 541 µH,  $R_g = 25 \Omega$ ,  $I_{AS} = 14 \text{ A}$  (see fig. 13). c.  $I_{SD} \le 17 \text{ A}$ ,  $I_{AJ} = 110 \text{ A/µs}$ , I
- 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

# IRFR020, IRFU020, SiHFR020, SiHFU020

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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL MIN. TYP. MAX. UNIT						
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	-	110		
Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup>	R <sub>thJA</sub>	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	-	3.0		

### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.073	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zon Colo Vellana Buis Consul		V <sub>DS</sub> :	= 60 V, V <sub>GS</sub> = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V,	V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8.4 A <sup>b</sup>	-	-	0.10	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 25 V, I <sub>D</sub> = 8.4 A	6.2	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	640	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 \text{ V},$	-	360	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	0 MHz, see fig. 5	-	79	-	
Total Gate Charge	$Q_g$	$V_{GS} = 10 \text{ V}$ $I_{D} = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		-	-	25	nC
Gate-Source Charge	Q <sub>gs</sub>			-	-	5.8	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	11	
Turn-On Delay Time	t <sub>d(on)</sub>			-	13	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, I_{D} = 17 \text{ A},$ $R_{G} = 18 \Omega, R_{D} = 1.7 \Omega, \text{ see fig. } 10^{\text{b}}$		-	58	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	25	-	
Fall Time	t <sub>f</sub>			-	42	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact <sup>c</sup>		-	4.5	-	الم
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	56	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 14 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 00 1	17 A dI/d+ 100 A/b	-	88	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 17  \text{A}, dI/dt = 100  \text{A}/\mu\text{s}^b$		-	0.29	0.64	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 12).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

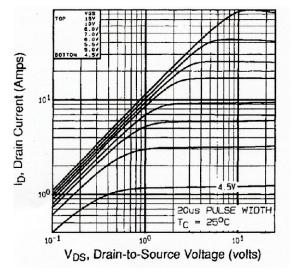


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

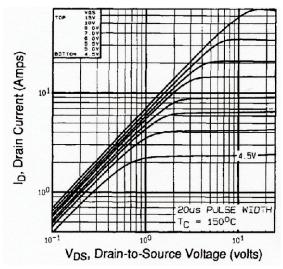


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

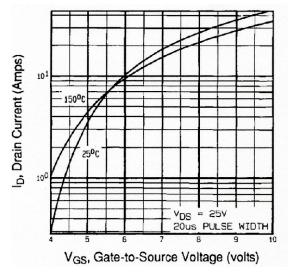


Fig. 3 - Typical Transfer Characteristics

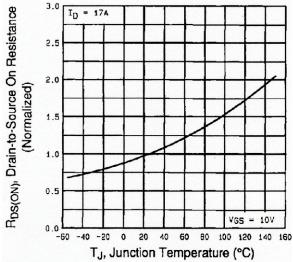


Fig. 4 - Normalized On-Resistance vs. Temperature



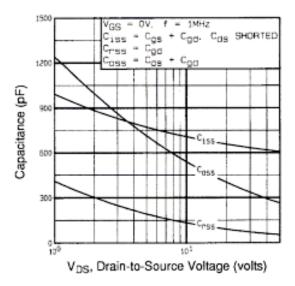


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

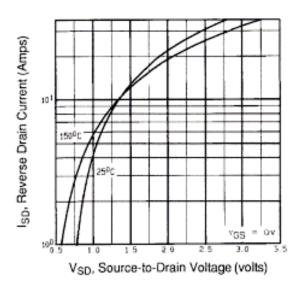


Fig. 7 - Typical Source-Drain Diode Forward Voltage

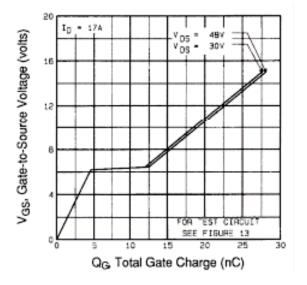


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

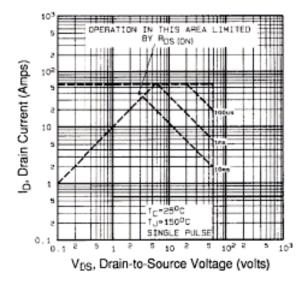


Fig. 8 - Maximum Safe Operating Area

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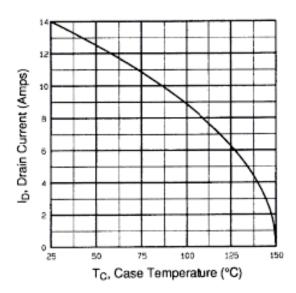


Fig. 9 - Maximum Drain Current vs. Case Temperature

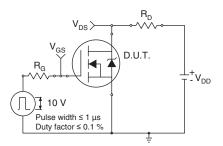


Fig. 10 - Switching Time Test Circuit

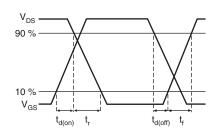


Fig. 11 - Switching Time Waveforms

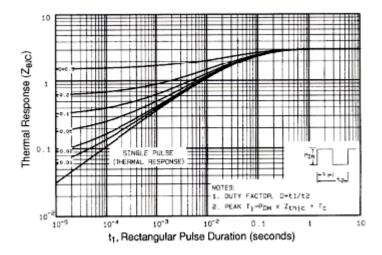


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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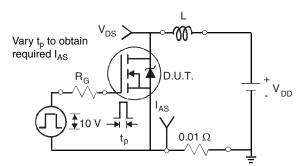


Fig. 13 - Unclamped Inductive Test Circuit

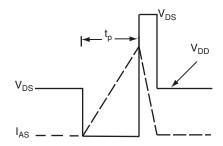


Fig. 14 - Unclamped Inductive Waveforms

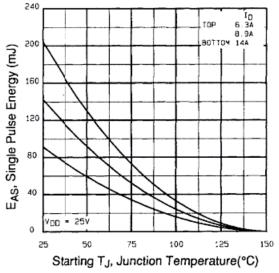


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

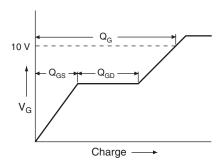


Fig. 16 - Basic Gate Charge Waveform

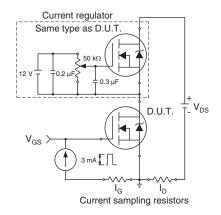
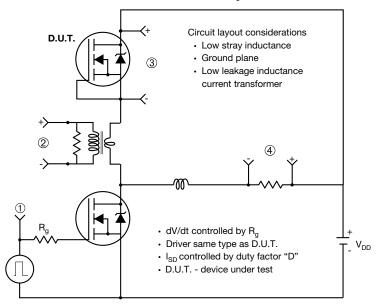


Fig. 17 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit



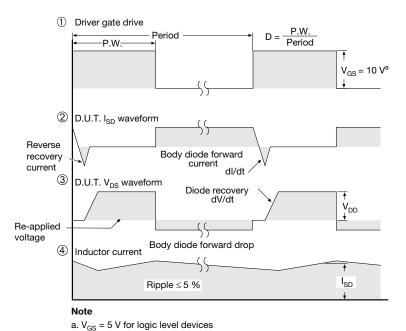
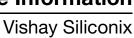


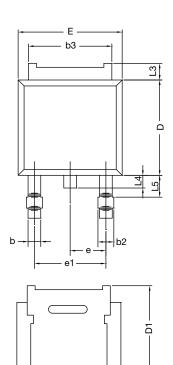
Fig. 18 - For N-Channel

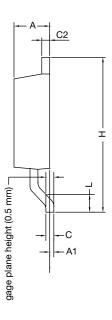
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# **TO-252AA Case Outline**





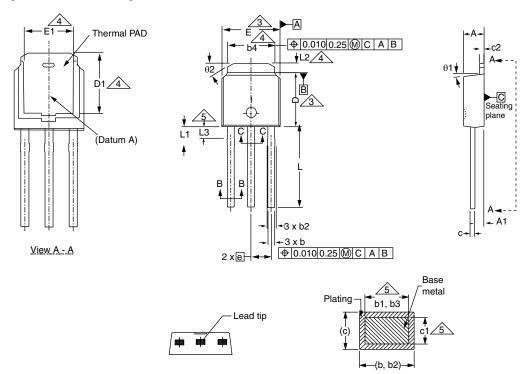
	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
e	2.28	BSC	0.090	BSC	
e1	4.56	4.56 BSC		BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

## DWG: 5347 Notes

• Dimension L3 is for reference only.



## **TO-251AA (HIGH VOLTAGE)**



Section B - B and C - C

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
е	2.29	BSC	2.29 BSC		
L	8.89	9.65	0.350	0.380	
L1	1.91	2.29	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.14	1.52	0.045	0.060	
θ1	0'	15'	0'	15'	
θ2	25'	35'	25'	35'	

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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Revision: 13-Jun-16 1 Document Number: 91000

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